

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Cheng-Lien Chiang

Assignee: Bridge Semiconductor Corporation

Title: SEMICONDUCTOR PACKAGE DEVICE THAT INCLUDES  
AN INSULATIVE HOUSING WITH A PROTRUDING  
PERIPHERAL PORTION

Serial No.: Unknown                      Filed:                      Herewith

Examiner: Unknown                      Group Art Unit:                      Unknown

Atty. Docket No.: BDG005-1-4

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COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Dear Sir:

Please amend the application as follows.

Title Amendments begin on page 2.

Abstract Amendments begin on page 3.

Specification Amendments begin on page 4.

Claim Amendments begin on page 8.

Remarks begin on page 20.

## **TITLE AMENDMENTS**

Replace the Title as follows:

**SEMICONDUCTOR PACKAGE DEVICE THAT INCLUDES AN INSULATIVE  
HOUSING WITH A PROTRUDING PERIPHERAL PORTION**